

MUR530AX ULTRAFAST PLASTIC RECTIFIER

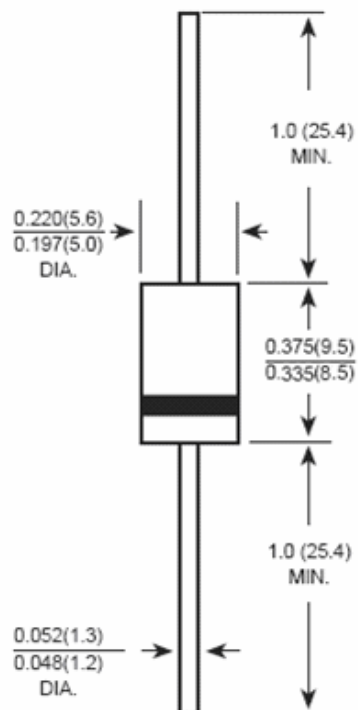
Applications:

- Switching Power Supply
- Power Switching Circuits
- General Purpose

Features:

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop, High Efficiency
- Low Power Loss
- Super Fast Recovery Time
- Plastic Case Material has UL Flammability Classification Rating 94V-O
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

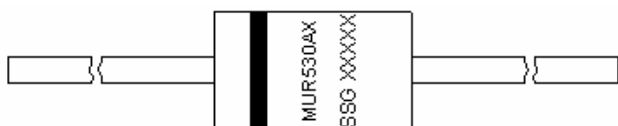
Mechanical Dimensions: In Inches / mm



DO-201AD

Technical Data
Data Sheet N0269, Rev. -
Marking Diagram:

Where XXXXX is YYWWL



MUR	= Device Type
5	= Forward Current (5A)
30	= Reverse Voltage (300V)
AX	= Configuration
SSG	= SSG
YY	= Year
WW	= Week
L	= Lot Number

Cautions: Molding resin
 Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
MUR530AX	DO-201AD (Pb-Free)	1250pcs / tape

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V_{RWM}	-	300	V
Max. Average Forward	$I_{F(AV)}$	50Hz, Sine wave, $T_C=100^\circ\text{C}$,	5	A
Max. Peak One Cycle Non-Repetitive Surge Current	I_{FSM}	50Hz, Half Sine wave	150	A

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop (Per leg)*	V_{F1}	@ $I_F=5A$, Pulse, $T_J = 25^\circ C$	1.3	V
	V_{F2}	@ $I_F=5A$, Pulse, $T_J = 125^\circ C$	1.2	V
Max. Reverse Current (Per leg)*	I_{R1}	@ $V_R = \text{rated } V_R$ $T_J = 25^\circ C$	10	μA
	I_{R2}	@ $V_R = \text{rated } V_R$ $T_J = 100^\circ C$	400	μA
Max. Reverse Recovery Time (Per leg)*	t_{rr}	$I_F=500mA$, $I_R=1A$, and $I_{rm}=250mA$	50	ns

* Pulse width < 300 μs , duty cycle < 2%

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Max. Junction Temperature	T_J	-	-55 to +150	$^\circ C$
Max. Storage Temperature	T_{stg}	-	-55 to +150	$^\circ C$
Maximum Thermal Resistance Junction to Case (Per Leg)	$R_{\theta JC}$		1.5	$^\circ C/W$
Approximate Weight	wt	-	1.02	g
Case Style	DO-201AD			

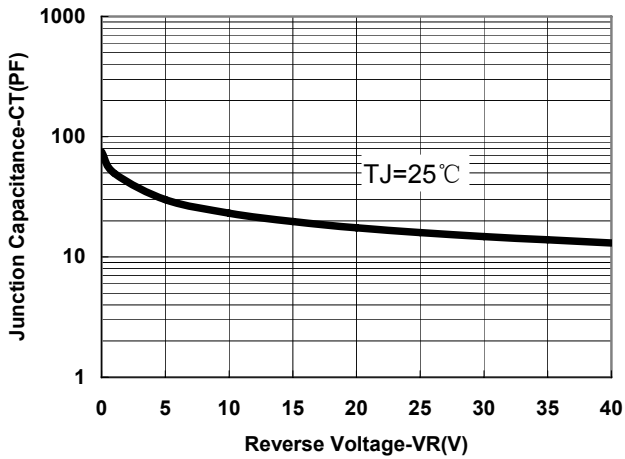


Fig.1-Typical Junction Capacitance

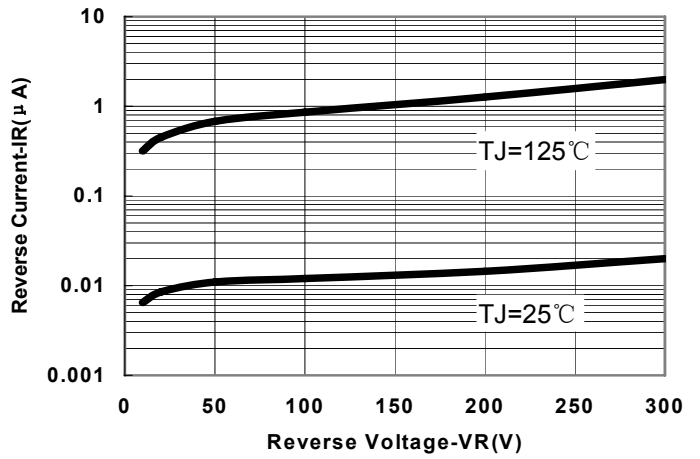


Fig.2-Typical Reverse Characteristics

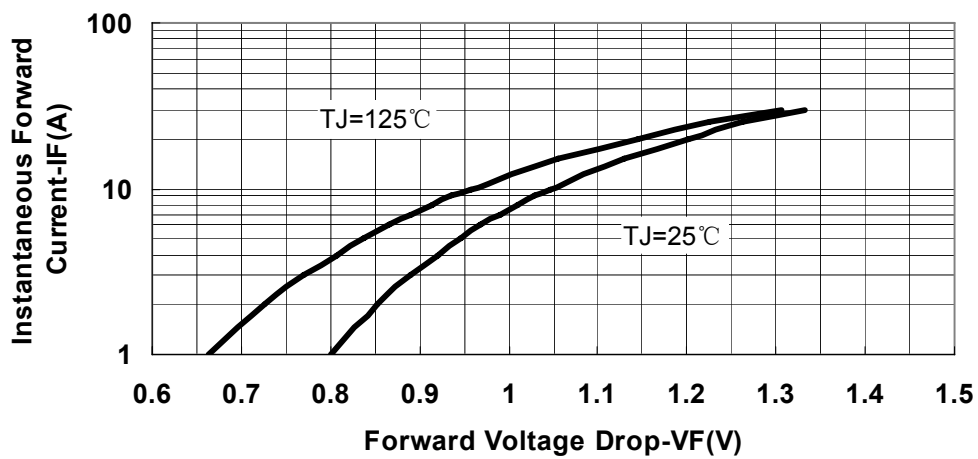


Fig.3-Typical Instantaneous Forward Characteristics

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